

Docket: 8021-160 (SS-18118-US)



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Sun et al. Examiner: Thanh V. Pham
Serial No.: 10/621,292 Group Art Unit: 2823
Filed: July 17, 2003
For: **METHOD OF FABRICATING SEMICONDUCTOR DEVICE USING A NICKEL SALICIDE PROCESS**

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Commissioner for Patents
P.O. Box 1450
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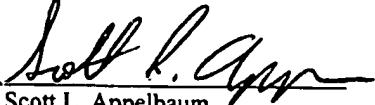
Sir:

In response to the Office Action dated July 28, 2005, please reconsider the above-identified application in light of the following remarks/arguments.

(Note: see item 10/11/2005 attached)
Do not enter

CERTIFICATE OF MAILING 37 C.F.R. §1.8(a)

I hereby certify that this correspondence (and any document referred to as being attached or enclosed) is being deposited with the United States Postal Service as first class mail, postage paid in an envelope addressed to: Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450, on September 27, 2005.


Scott L. Appelbaum

Dated: September 27, 2005